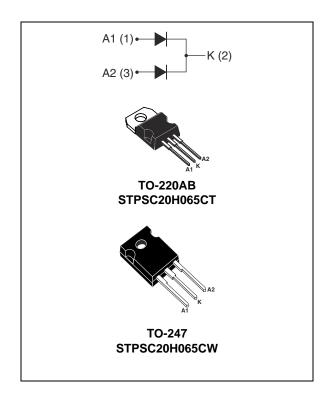


STPSC20H065C

650 V power Schottky silicon carbide diode

Datasheet - production data



Features

- No or negligible reverse recovery
- Switching behavior independent of temperature
- Dedicated to PFC applications
- · High forward surge capability

Description

The SiC diode is an ultrahigh performance power Schottky diode. It is manufactured using a silicon carbide substrate. The wide band gap material allows the design of a Schottky diode structure with a 650 V rating. Due to the Schottky construction, no recovery is shown at turn-off and ringing patterns are negligible. The minimal capacitive turn-off behavior is independent of temperature.

Especially suited for use in PFC applications, this ST SiC diode will boost the performance in hard switching conditions. Its high forward surge capability ensures a good robustness during transient phases.

Table 1. Device summary

Symbol	Value
I _{F(AV)}	2 x 10 A
V_{RRM}	650 V
T _j (max)	175 °C

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1 Characteristics

Table 2. Absolute ratings (limiting values per diode at 25 °C unless otherwise specified)

Symbol	Para	Value	Unit		
V_{RRM}	Repetitive peak reverse voltage		650	V	
I _{F(RMS)}	Forward rms current		22	Α	
1	Average forward current	$T_c = 135 ^{\circ}C^{(1)}$, DC, per diode	10	۸	
I _{F(AV)} A	Average forward current	T _c = 125 °C ⁽²⁾ , per device	20	Α	
	Curae non repetitive femuera	$t_p = 10 \text{ ms sinusoidal, } T_c = 25 \text{ °C}$			
I _{FSM}	Surge non repetitive forward current	$t_p = 10 \text{ ms sinusoidal, } T_c = 125 ^{\circ}\text{C}$	80	Α	
	Current	$t_p = 10 \mu s square, T_c = 25 °C$	470		
I _{FRM}	Repetitive peak forward current	$T_c = 135 \text{ °C}^{(1)}, T_j = 175 \text{ °C}, \delta = 0.1$	36	Α	
T _{stg}	Storage temperature range	-55 to +175	°C		
Tj	Operating junction temperature ⁽³⁾	-40 to +175	°C		

^{1.} Value based on $R_{th(j-c)}$ max (per diode)

Table 3. Thermal resistance

Symbol	Parameter			Value		I Init
Symbol				Тур.	Max.	Unit
		Per diode	TO-247	1.25	1.5	
5	Junction to case per diode		TO-220AB			
R _{th(j-c)}		Tatal	TO-247	0.83	0.95	°C/W
		Total	TO-220AB	0.63		
R _{th(c)}	Coupling				0.4	

When the two diodes 1 and 2 are used simultaneously:

 ΔT_i (diode 1) = P(diode 1) x R_{th(j-c)}(Per diode) + P(diode 2) x R_{th(c)}

Table 4. Static electrical characteristics per diode

Symbol	Parameter	Tests conditions		Min.	Тур.	Max.	Unit
I _R ⁽¹⁾	Reverse leakage current	T _j = 25 °C	$V_R = V_{RRM}$	-	9	100	μΑ
'R`	Reverse leakage current	T _j = 150 °C		-	85	425	
V _E (2)	Forward voltage drop	T _j = 25 °C	I _F = 10 A	-	1.56	1.75	\/
V _F ()	roiward vollage drop	T _j = 150 °C	IF = 10 A	-	1.98	2.5	V

^{1.} $t_p = 10 \text{ ms}, \delta < 2\%$

To evaluate the conduction losses use the following equation:

$$P = 1.35 \times I_{F(AV)} + 0.115 \times I_{F^{2}(RMS)}$$

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^{2.} Value based on $R_{\text{th(j-c)}}$ max (per device)

^{3.} $\frac{dPtot}{dTj} < \frac{1}{Rth(j-a)}$ condition to avoid thermal runaway for a diode on its own heatsink

^{2.} $t_p = 500 \ \mu s, \ \delta < 2\%$

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Table 5. Dynamic electrical characteristics per diode

Symbol	Parameter	Test conditions	Тур.	Unit
Q _{cj} ⁽¹⁾	Total capacitive charge	V _R = 400 V	28.5	nC
C	Total capacitance	$V_R = 0 \text{ V}, T_c = 25 \text{ °C}, F = 1 \text{ MHz}$	480	, E
C _j	Total capacitance	$V_R = 400 \text{ V}, T_c = 25 \text{ °C}, F = 1 \text{ MHz}$	48	pF

^{1.} Most accurate value for the capacitive charge: $Q_{cj} = \int_{1}^{V_{OUT}} c_j(v_R).dv_R$

Figure 1. Forward voltage drop versus forward Figure current (typical values per diode, low level) curre

| F_M(A) | Pulse test : t_p=500µs | T_a=25 °C | T_a=150 °C | T_a=150 °C | T_a=175 °C | Results of the second of the second

Figure 2. Forward voltage drop versus forward current (typical values per diode, high level)

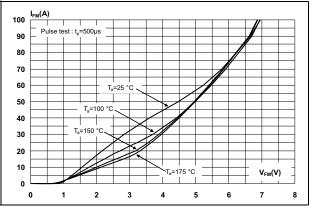
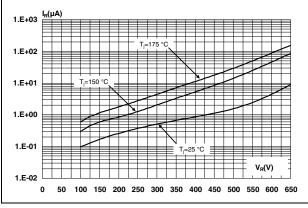
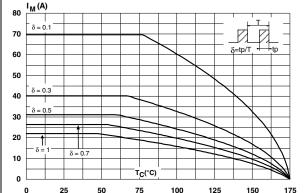


Figure 3. Reverse leakage current versus reverse voltage applied (typical values per diode)

Figure 4. Peak forward current versus case temperature, per diode

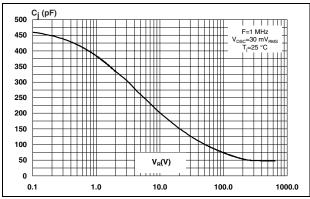




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Figure 5. Junction capacitance versus reverse voltage applied (typical values, per diode)

Figure 6. Relative variation of thermal impedance junction to case versus pulse duration per diode



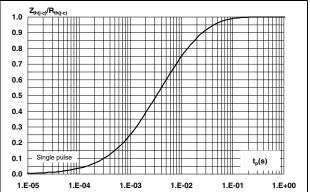
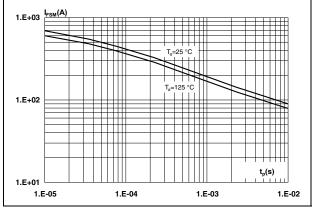
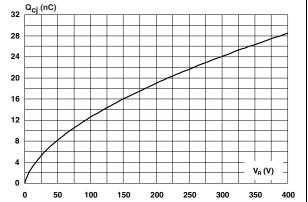


Figure 7. Non-repetitive peak surge forward current versus pulse duration per diode (sinusoidal waveform)

Figure 8. Total capacitive charges versus reverse voltage applied (typical values per diode)





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2 Package information

- Epoxy meets UL94, V0
- Cooling method: conduction (C)
- · Recommended torque value:
 - TO-220AB 0.4 to 0.6 N⋅m,
 - TO-247 0.55 N⋅m (1.0 N⋅m maximum)

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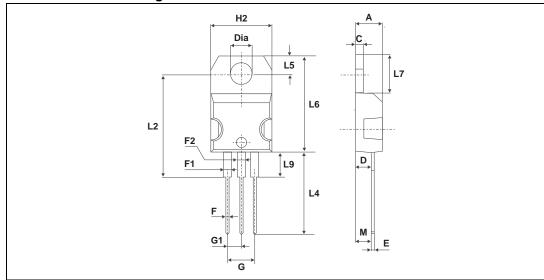


Figure 9. TO-220AB dimension definitions



Package information STPSC20H065C

Table 6. TO-220AB dimension values

	Dimensions						
Ref.	Millim	neters	Inches				
	Min.	Max.	Min.	Max.			
А	4.40	4.60	0.173	0.181			
С	1.23	1.32	0.048	0.051			
D	2.40	2.72	0.094	0.107			
Е	0.49	0.70	0.019	0.027			
F	0.61	0.88	0.024	0.034			
F1	1.14	1.70	0.044	0.066			
F2	1.14	1.70	0.044	0.066			
G	4.95	5.15	0.194	0.202			
G1	2.40	2.70	0.094	0.106			
H2	10	10.40	0.393	0.409			
L2	16.4	typ.	0.645 typ.				
L4	13	14	0.511	0.551			
L5	2.65	2.95	0.104	0.116			
L6	15.25	15.75	0.600	0.620			
L7	6.20	6.60	0.244	0.259			
L9	3.50	3.93	0.137	0.154			
М	2.6 typ.		0.102	typ.			
Diam.	3.75	3.85	0.147	0.151			

STPSC20H065C Package information

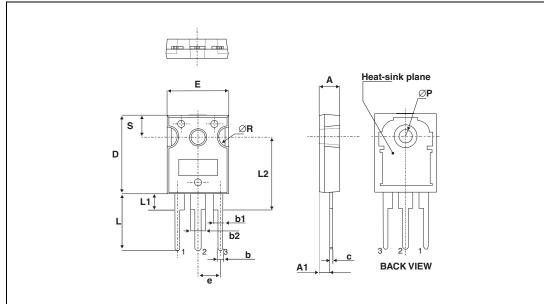


Figure 10. TO-247 dimension definitions

Table 7. TO-247 dimension values

	Dimensions						
Ref.	Millimeters			Inches			
	Min.	Тур.	Max.	Min.	Тур	Max.	
А	4.85		5.15	0.191		0.203	
A1	2.20		2.60	0.086		0.102	
b	1.00		1.40	0.039		0.055	
b1	2.00		2.40	0.078		0.094	
b2	3.00		3.40	0.118		0.133	
С	0.40		0.80	0.015		0.031	
D ⁽¹⁾	19.85		20.15	0.781		0.793	
E	15.45		15.75	0.608		0.620	
е	5.30	5.45	5.60	0.209	0.215	0.220	
L	14.20		14.80	0.559		0.582	
L1	3.70		4.30	0.145		0.169	
L2	18.50 typ.			0.728 typ.			
ØP ⁽²⁾	3.55		3.65	0.139		0.143	
ØR	4.50		5.50	0.177		0.217	
S	5.30	5.50	5.70	0.209	0.216	0.224	

^{1.} Dimension D plus gate protrusion does not exceed 20.5 mm

^{2.} Resin thickness around the mounting hole is not less than 0.9 \mbox{mm}



Ordering information STPSC20H065C

3 Ordering information

Table 8. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
STPSC20H065CT	STPSC20H065C	TO-220AB	1.86 g	50	Tube
STPSC20H065CW	STPSC20H065CW	TO-247	4.43 g	30	Tube

4 Revision history

Table 9. Document revision history

Date	Revision	Changes
31-Aug-2012	1	First issue.
10-Oct-2012	2	Added Max. values to <i>Table 3</i> .
07-Nov-2013	3	Updated Figure 1 and Figure 2.

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